

POC-40 Series

Intel[®] Elkhart Lake Atom[®] x6211E/ x6413E Extreme-compact Embedded Computer with 2x GbE and 2x USB 3.1



Key Features

- Intel[®] Elkhart Lake Atom[®] x6211E/ x6413E processor
- · 52 x 89 x 112 mm extremely compact form factor
- Rugged -25°C to 70°C fanless wide-temperature operation
- $\cdot\,$ Two GigE ports, two USB 3.1 Gen1 ports and two USB2.0 ports
- · M.2 2280 M key SATA storage interface
- · One M.2 B key socket supporting 5G/ 4G 3042/ 3052 modules
- · One M.2 E key socket for WiFi 5/ WiFi 6 modules
- $\cdot\,$ One COM port with RS-232/ 422/ 485 modes and three RS-232 COM ports

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Introduction

POC-40 Series is an extremely compact fanless computer with dimensions measuring just 52 x 89 x 112 mm. It features Elkhart Lake Atom[®] processor and is designed for space-restricted applications such as factory data collection, rugged edge computing and mobile gateway.

Utilizing Intel's 10nm process technology, the new Elkhart Lake Atom[®] x6211E and x6413E processor can deliver up to 1.8 times the performance boost over its previous generation. In comparison to POC-200, POC-40 provides 1.9 times computing performance at only half the size. It features generic I/O functions, such as two Gigabit Ethernet ports, four USB 3.1 Gen1/ 2.0 ports, four COM ports and optional isolated digital I/Os for industrial communication and control. In addition, by adopting dedicated M.2 B key and E key slots, the POC-40 can fully harness the bandwidth of 5G and WiFi 6 wireless communications to provide wide-area coverage and real-time data transmission for industrial and mobile gateway applications.

With a similar footprint as a PICO-ITX motherboard, Neousys' POC-40 is perfect for projects that require above par performance in an extremely compact package. Ideal for both edge computing and gateway applications, it is a low power consumption and lightweight fanless computer that offers wide-temperature operation for harsh environments.

Specifications

	POC-40+	POC-40		POC-40+
System Core			Internal Expansio	on Bus
Processor	Intel [®] Atom [®] x6413E quad-core 1.5GHz/ 3.0GHz 9W processor	Intel [®] Atom [®] x6211E dual-core 1.3GHz/ 3.0GHz 6W proc essor	M.2 B key	N/A
Graphics	Integrated Intel [®] UHD Graphics			
Memory	Up to 32 GB DDR4-3200 SDRAM (one SODIMM slot)		M.2 E key	1x M.2 2230 E key s
ТРМ	Supports fTPM 2.0		Mini-PCIe	1x full-size mini PCI Express socket with internal SIM socket
Panel I/O Interfa	ice		Power Supply	
Ethernet		y Intel [®] I210 GbE controllers	DC Input	1x 4-pin pluggable terminal b ignition power control
USB 3.1	2x USB 3.1 Gen1 (5 Gbps) ports		Remote Control	0 1
USB 2.0	2x USB 2.0 ports			1x 4-pin pluggable terminal
Video Port	1x DisplayPort connector, supporting 4096 x 2160 resolution @ 60Hz		Mechanical	
			Dimension	52 mm (W) x 89 mm (D) x 11
Serial Port	1x software-programmable RS- 232/ 422/ 485 port (COM1) 1x isolated RS-422/485 port (COM2)	1x software-programmable RS- 232/ 422/ 485 port (COM1) 3x 3-wire RS-232 ports (COM2/ COM3/COM4)	Weight	0.6 kg
			Mounting	DIN-rail mount (standard) or
			Environmental	
Isolated Digital I/O	Optional 4-ch isolated digital input and 4-ch isolated digital output		Operating Temperature	-25°C ~ 60°C
Storage Interface	1x M.2 2280 M key SATA interfac	e	Storage Temperature	-2
			Humidity	10%~90% , non-condensing

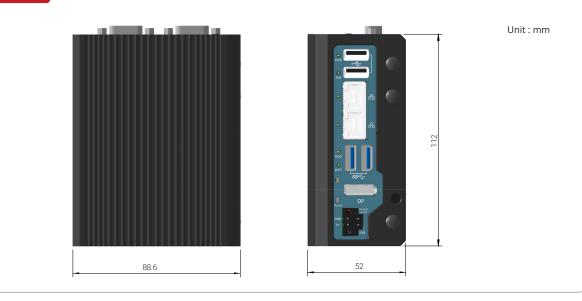
	POC-40+	POC-40			
Internal Expansion Bus					
M.2 B key	N/A	1x M.2 3042/ 3052 B key socket with internal SIM socket for 4G/ 5G module			
M.2 E key	1x M.2 2230 E key socket for WiFi 5/ WiFi 6 module				
Mini-PCIe	1x full-size mini PCI Express socket with internal SIM socket	N/A			
Power Supply					
DC Input	1x 4-pin pluggable terminal block for 12-20V DC input with optional ignition power control				
Remote Control	1x 4-pin pluggable terminal block for remote control				
Mechanical					
Dimension	52 mm (W) x 89 mm (D) x 112 mm (H)				
Weight	0.6 kg				
Mounting	DIN-rail mount (standard) or Wall-mount (optional)				
Environmental					
Operating Temperature	-25°C ~ 60°C	-25°C ~ 70°C			
Storage Temperature	-40°C ~85°C				
Humidity	10%~90% , non-condensing				
Vibration	Operating, MIL-STD-810G, Method 514.6, Category 4				
Shock	Operating, MIL-STD-810G, Method 516.6, Procedure I, Table 516.6-II				
EMC	CE/FCC Class A, according to EN 55032 & EN 55024				



Appearance



Dimensions



Ordering Information

Model No.	Product Description
POC-40	Intel [®] Elkhart Lake Atom [®] x6211E Extreme-compact Embedded Computer with 2x GbE and 2x USB 3.1
POC-40-DIO	Intel® Elkhart Lake Atom® x6211E Extreme-compact Embedded Controller with with 2x GbE and 2x USB 3.1 and 8x isolated DIO
POC-40-IGN	Intel® Elkhart Lake Atom® x6211E Extreme-compact Embedded Controller with with 2x GbE, 2x USB 3.1 and ignition power control
POC-40+	Intel® Elkhart Lake x6413E Extreme-compact IOT Gateway Computer with 2x GbE, 2x USB 3.1 and 1x isolated RS422/485
POC-40+-DIO	Intel® Elkhart Lake x6413E Extreme-compact IOT Gateway Computer with 2x GbE, 2x USB 3.1, 1x isolated RS422/485 and 8x isolated DIO
POC-40+-IGN	Intel® Elkhart Lake x6413E Extreme-compact IOT Gateway Computer with 2x GbE, 2x USB 3.1, 1x isolated RS422/485 and ignition power control

Optional Accessories

PA-60W-OW	60W AC/DC power adapter with 12V, 5A DC output, cord end terminals for terminal block. Operating temperature : -30 to 60 °C	
Wmkit-V-POC40	Wall-mount assembly for POC-40 series, vertical type	
Cbl-DB9F-3DB9M-15CM	1x DB9 (Female) to 3x DB9 (Male), length: 15CM	